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L6 ANSWER 1 OF 11 USPATFULL

AB Silicon beads are produced by chemical vapor deposition (CVD) on seed particles generated internal to a CVD reactor. The reactor has multiple zones, including an inlet zone where beads are maintained in a submerged spouted bed and an upper zone where beads are maintained in a bubbling fluidized bed. A tapered portion of the upper zone segregates beads by size. Systems for inspecting, sorting and transporting product beads are also disclosed.

CAS INDEXING IS AVAILABLE FOR THIS PATENT. AN 1998:115257 USPATFULL

TI Silicon deposition reactor apparatus

IN Lord, Stephen M., Encinitas, CA, United States

Milligan, Robert J., Moses Lake, WA, United States *

PA Advanced Silicon Materials, Inc., Moses Lake, WA, United States (U.S.

corporation)

PI US 5810934 19980922 AI US 4870085 19950607 (8)

RLI Continuation of Ser. No. 481801, filed on 7 Jun 1995

DT Utility FS Granted

EXNAM Primary Examiner: Bueker, Richard

LREP Klarquist Sparkman Campbell Leigh & Whinston, LLP

CLMN Number of Claims: 28 ECL Exemplary Claim: 1

DRWN 14 Drawing Figure(s); 6 Drawing Page(s)

LN.CNT 3020

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L6 ANSWER 2 OF 11 USPATFULL

AB Silicon beads are produced by chemical vapor deposition (CVD) on seed particles generated internal to a CVD reactor. The reactor has multiple zones, including an inlet zone where beads are maintained in a submerged spouted bed and an upper zone where beads are maintained in a bubbling fluidized bed. A tapered portion of the upper zone segregates beads by size. Systems for inspecting, sorting and transporting product beads are also disclosed.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

AN 1998:101432 USPATFULL

TI Method for silicon deposition

IN Lord, Stephen M., Encinitas, CA, United States Milligan, Robert J., Moses Lake, WA, United States

PA Advanced Silicon Materials, Inc., Moses Lake, WA, United States (U.S.

corporation)

PI US 5798137 19980825 AI US 1995-481801 19950607 (8)

DT Utility FS Granted

EXNAM Primary Examiner: Beck, Shrive; Assistant Examiner: Meeks, Timothy

LREP Klarquist Sparkman Campbell Leigh & Whinston, LLP

CLMN Number of Claims: 35 ECL Exemplary Claim: 1

DRWN 14 Drawing Figure(s); 6 Drawing Page(s)

LN.CNT 3117

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L6 ANSWER 3 OF 11 USPATFULL

AB An improved reactor for a high-temperature deposition reaction on seed

particles is constructed with a fluidized bed which is divided into a heating zone and a reaction zone by a partition. Seed particles in the heating zone are fluidized by a carrier gas and are heated by microwaves. On the other hand, the reaction zone for the deposition reaction, through which reaction gases pass, is heated by particle mixing between the reaction zone and the upper section of the heating zone. Subsequently, a desired reaction temperature at the reaction zone is maintained stable without deteriorating the microwave heating of the heating zone.

CAS INDEXING IS AVAILABLE FOR THIS PATENT. AN95:5754 USPATFULL TΙ Fluidized bed reactor heated by microwaves IN Kim, Hee Y., Daejeon, Korea, Republic of Song, Yong M., Daejeon, Korea, Republic of Jeon, Jong Y., Daejeon, Korea, Republic of Kwon, Dae H., Daejeon, Korea, Republic of Lee, Kang M., Daejeon, Korea, Republic of Lee, Jae S., Daejeon, Korea, Republic of Park, Dong S., Daejeon, Korea, Republic of PA Korea Research Institute of Chemical Technology, Daejeon, Korea, Republic of (non-U.S. corporation) ΡI US 5382412 19950117 ΑI US 1993-55239 19930428 (8) Continuation-in-part of Ser. No. US 1992-967100, filed on 27 Oct 1992, now abandoned DTUtility FS Granted Primary Examiner: Santiago, Amalia L. EXNAM Jordan and Hamburg LREP Number of Claims: 7 CLMN ECL Exemplary Claim: 1 4 Drawing Figure(s); 4 Drawing Page(s) DRWN LN.CNT 1047 CAS INDEXING IS AVAILABLE FOR THIS PATENT.

ANSWER 4 OF 11 USPATFULL L6

AB An improved method is provided for the deposition of high-purity silicon on silicon particles from silicon source gases in a fluidized bed reactor which is divided into a heating zone and a reaction zone by a partition. Silicon particles in the heating zone are fluidized by a carrier gas such as hydrogen and are heated by microwaves. On the other hand, the reaction zone for the deposition of silicon, through which reaction gases including the silicon source pass, is heated by particle mixing between the reaction zone and the upper section of the heating zone. Subsequently, a desired reaction temperature at the reaction zone is maintained stable without deteriorating the microwave heating of the heating zone.

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CAS INDEXING IS AVAILABLE FOR THIS PATENT.
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94:110560 USPATFULL ΑN

ΤI Heating of fluidized bed reactor by microwaves

Kim, Hee Y., Daejeon, Korea, Republic of IN Song, Yong M., Daejeon, Korea, Republic of Jeon, Jong Y., Daejeon, Korea, Republic of Kwon, Dae H., Daejeon, Korea, Republic of Lee, Kang M., Daejeon, Korea, Republic of Lee, Jae S., Daejeon, Korea, Republic of Park, Dong S., Daejeon, Korea, Republic of

PA Korea Research Institute of Chemical Technology, Daejeon, Korea,

Republic of (non-U.S. corporation)

US 5374413 19941220 PΙ

US 1993-55240 19930428 (8) ΑI Continuation-in-part of Ser. No. US 1992-967100, filed on 27 Oct 1992, RLI now abandoned DTUtility Granted EXNAM Primary Examiner: Santiago, Amalia L. LREP Jordan and Hamburg Number of Claims: 23 CLMN Exemplary Claim: 14 ECL DRWN 4 Drawing Figure(s); 4 Drawing Page(s) LN.CNT 1033 CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L6 ANSWER 5 OF 11 USPATFULL

Embodiments of magnetoplasmadynamic processors are disclosed which utilize specially designed cathode-buffer, anodeionizer and vacuum-insulator/isolator structures to transform a working fluid into a beam of fully ionized plasma. The beam is controlled both in its size and direction by a series of magnets which are mounted in surrounding relation to the cathode, anode, vacuum insulator/isolators and plasma beam path. As disclosed, the processor may be utilized in many diverse applications including the separation of ions of differing weights and/or ionization potentials and the deposition of any ionizable pure material. Several other applications of the processor are disclosed.

94:107832 USPATFULL AN Magnetoplasmadynamic processor, applications thereof and methods ΤI Cann, Gordon L., Laguna Beach, CA, United States IN Celestech, Inc., Irvine, CA, United States (U.S. corporation) PA US 34806 19941213 PΤ US 4682564 19870728 (Original) 19920504 (7) ΑI US 1992-879560 19830711 (Original) US 1983-512728 Continuation of Ser. No. US 1989-387977, filed on 28 Jul 1989, now RLI abandoned which is a continuation-in-part of Ser. No. US 1980-210241, filed on 25 Nov 1980, now abandoned DT Reissue Granted FS

EXNAM Primary Examiner: Owens, Terry J.

LREP Weil, Gotshal & Manges

CLMN Number of Claims: 109

ECL Exemplary Claim: 108

DRWN 31 Drawing Figure(s); 22 Drawing Page(s)

LN.CNT 3197

L6 ANSWER 6 OF 11 USPATFULL

As system for setting an analysis condition for a thermal analysis of a fluid inside an apparatus, wherein a gas flow-in temperature in the apparatus, a gas flow-in rate, and an apparatus outer wall temperature are set as critical conditions, the interior of the apparatus being under a high pressure atmosphere and heated by a heater, an analysis mesh shape, a pressure inside the apparatus and other values, and a heater power, are set as initial values, and a simulation is carried out so that an optimum operating condition is obtained, wherein the relationship between heater power by which a heater monitoring temperature is maintained at a constant value and a gas flow rate at the entrance while changing the apparatus internal pressure is obtained by a trial experiment, and the simulation is carried out by changing the gas flow rate at the entrance in accordance with the heater power and the gas flow rate at the entrance set as the initial value.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

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AN
       92:84556 USPATFULL
ΤI
       System for setting analysis condition for a thermal analysis of a fluid
       inside an apparatus
IN
       Ishida, Masanobu, Yokohama, Japan
       Yamaguchi, Yukio, Kawasaki, Japan
       Orito, Fumio, Abiko, Japan
       Katano, Kizuku, Tsukuba, Japan
       Okada, Hideo, Chikushino, Japan
       Yajima, Fumikazu, Inashiki, Japan
       Mitsubishi Kasei Polytec Company, both of, Japan (non-U.S. corporation)
PA
       Mitsubishi Kasai Corporation, both of, Japan (non-U.S. corporation)
       US 5154795
PΙ
                               19921013
       US 1990-535769
ΑI
                               19900611 (7)
PRAI
       JP 1989-149240
                           19890612
       JP 1990-51337
                           19900302
DT
       Utility
FS
       Granted
EXNAM Primary Examiner: Kunemund, Robert
       Burgess, Ryan & Wayne
LREP
       Number of Claims: 6
CLMN
ECL
       Exemplary Claim: 1
DRWN
       11 Drawing Figure(s); 7 Drawing Page(s)
LN.CNT 733
CAS INDEXING IS AVAILABLE FOR THIS PATENT.
L6
     ANSWER 7 OF 11 USPATFULL
AΒ
       In a process for growing enzyme crystals, small crystals are
       continuously removed from a crystallizer, dissolved and returned to the
       crystallizer to maintain a supersaturated state. The method permits the
       growing of large crystalline enzymes of uniform size of about 0.5 to 1
       mm. Solid materials can be coated with crystalline enzymes by placing a
       solid material in the crystallizer such that crystals deposit on the
       solid material. The process is preferably used to produce crystalline
       glucose isomerase.
AN
       92:46977 USPATFULL
TI
       Method for producing crystalline glucose isomerase
       Visuri, Kalevi, Kantvik, Finland
IN
PΑ
       Stabra AG, Zug, Switzerland (non-U.S. corporation)
PΙ
       US 5120650
                               19920609
       US 1989-421137
                               19891013 (7)
ΑI
       Utility
DT
       Granted
FS
EXNAM Primary Examiner: Naff, David M.
LREP
       Passe, James G.
CLMN
       Number of Claims: 24
       Exemplary Claim: 1
       3 Drawing Figure(s); 3 Drawing Page(s)
LN.CNT 754
    ANSWER 8 OF 11 USPATFULL
1.6
       The present invention is directed to an improved process for producing
AΒ
       ultra high purity polycrystalline silicon which process provides for
       increased production capacity and electrical power efficiency. The
       process comprises recycling the exhaust gases of the silane pyrolysis
       reactor after the gases have been preferably first cooled and filtered
       utilizing a pocket-type reaction zone enclosure having a particular
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effective radius thereby effectively decreasing the amount of silicon powder formation. Preferably, the rate of recycle flow is sufficient to entrain silicon powder in the reactor and remove the powder from the

reactor with the exiting exhaust gases.

CAS INDEXING IS AVAILABLE FOR THIS PATENT. 89:34221 USPATFULL TI Process for the production of ultra high purity polycrystalline silicon IN Breneman, William C., Sistersville, WV, United States Flagella, Robert N., Ridgefield, WA, United States Gaston, Jon M., Montreal, Canada Hagan, David W., Vancouver, WA, United States PA Union Carbide Corporation, Danbury, CT, United States (U.S. corporation) PΙ US 4826668 19890502 US 1987-62256 ΑI 19870611 (7) DTUtility FS Granted EXNAM Primary Examiner: Dixon, Jr., William R.; Assistant Examiner: Griffis, LREP Reinisch, Morris N. CLMN Number of Claims: 30 ECL Exemplary Claim: 1 DRWN 20 Drawing Figure(s); 20 Drawing Page(s) LN.CNT 895 CAS INDEXING IS AVAILABLE FOR THIS PATENT. L6 ANSWER 9 OF 11 USPATFULL AΒ Embodiments of magnetoplasmadynamic processors are disclosed which utilize specially designed cathode-buffer, anodeionizer and vacuum-insulator/isolator structures to transform a working fluid into a beam of fully ionized plasma. The beam is controlled both in its size and direction by a series of magnets which are mounted in surrounding relation to the cathode, anode, vacuum insulator/isolators and plasma beam path. As disclosed, the processor may be utilized in many diverse applications including the separation of ions of differing weights and/or ionization potentials and the deposition of any ionizable pure material. Several other applications of the processor are disclosed. ΑN 87:53002 USPATFULL TΙ Magnetoplasmadynamic processor, applications thereof and methods Cann, Gordon L., 17751-F Sky Park East, Irvine, CA, United States 92714 IN PΙ US 4682564 19870728 ΑI US 1983-512728 19830711 (6) Continuation-in-part of Ser. No. US 1980-210241, filed on 25 Nov 1980, RLI now abandoned DTUtility FS Granted EXNAM Primary Examiner: Silverberg, Sam LREP Sherman and Shalloway CLMN Number of Claims: 89 ECLExemplary Claim: 1 DRWN 31 Drawing Figure(s); 22 Drawing Page(s) LN.CNT 2941 L6 ANSWER 10 OF 11 USPATFULL AΒ The invention pertains to growth of silicon bodies from a melt and comprises enveloping the liquid/solid interface with a mixture of an inert gas and more than a trace amount of a carbon-containing gas. The carbon-containing gas may be a compound of carbon and oxygen such as CO or CO.sub.2, and oxygen gas also may be introduced to the growth zone. CAS INDEXING IS AVAILABLE FOR THIS PATENT. 83:53274 USPATFULL ΑN Control of atmosphere surrounding crystal growth zone TI IN Wald, Fritz, Wayland, MA, United States Kalejs, Juris P., Wellesley, MA, United States PΑ Mobil Solar Energy Corporation, Waltham, MA, United States (U.S.

corporation) PΙ US 4415401 19831115 US 1980-216300 ΑI 19801215 (6) RLI Continuation-in-part of Ser. No. US 1980-129075, filed on 10 Mar 1980, now abandoned DТ Utility FS Granted EXNAM Primary Examiner: Bernstein, Hiram H. Schiller & Pandiscio LREP Number of Claims: 24 CLMNECL Exemplary Claim: 1 5 Drawing Figure(s); 2 Drawing Page(s) DRWN LN.CNT 894 CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L6 ANSWER 11 OF 11 USPATFULL

AΒ

In the production of silicon articles at an elevated temperature, a stream comprising a controlled mixture of an oxygen-containing first gas and a second gas is admitted to the processing chamber. The first gas is one which partially dissociates under the conditions in the chamber to form both oxygen and the second gas. The second gas is one which is not harmful to silicon at the conditions in the chamber. Substantially equilibrium conditions are established in the chamber so that the dissociation of the first gas to oxygen occurs reversibly. The partial pressure of oxygen (P.sub.O.sbsb.2) is sensed in the chamber during processing of the article. In response to the P.sub.O.sbsb.2 level, the ratio of the rates of flow of the oxygen-containing gas and the second gas is adjusted so as to maintain the P.sub.O.sbsb.2 at a level less than about 10.sup.-6 atmosphere, and usually no greater than about 10.sup.-10 atmosphere, at which the density of oxygen-related defects in the processed silicon article is acceptably low. Oxygen-related defects in the silicon are thereby reduced. If graphite structures are present in the hot zone of the processing chamber, they are preferably coated with an impervious coating which will stand the high temperature and will prevent the gas stream from coming into contact with the hot graphite. Carbon-related defects in the silicon are thereby also reduced.

CAS INDEXING IS AVAILABLE FOR THIS PATENT. 83:36852 USPATFULL AN Control of oxygen- and carbon-related crystal defects in silicon TI processing Ownby, Paul D., Rolla, MO, United States IN Grayson, Paul E., Joplin, MO, United States Eagle-Picher Industries, Inc., Cincinnati, OH, United States (U.S. PA corporation) US 4400232 19830823 PΙ ΑI US 1981-319638 19811109 (6) DTUtility FS Granted EXNAM Primary Examiner: Bernstein, Hiram H. Wood, Herron & Evans LREP Number of Claims: 9 CLMN Exemplary Claim: 1 ECL 3 Drawing Figure(s); 1 Drawing Page(s) DRWN LN.CNT 386 CAS INDEXING IS AVAILABLE FOR THIS PATENT.

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06 MAY 2003)

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L1	439960	S (SINGLE OR MONO) (8A) (CRYSTAL?)
L2	439960 \$	S (SINGLE OR MONO) (8A) (CRYSTAL?)
L3	342517 \$	G (COOL? OR REFRIGERAT?)(8A)(WATER)
L4	13032 9	G (PULL? OR LIFT?)(8A)(CRYSTAL?)
L5	61525	(MEASUR? OR GAUGE OR DEMARCAT? OR DETERMIN? OR MARK?) (8A) (FLO
L6		S L1 AND L3 AND L4 AND L5

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